INTEGRATED CIRCUITS

DATA SHEET

74ALVCH162245

16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

Product specification

1998 Jun 29

IC24 Data Handbook





16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

74ALVCH162245

FEATURES

- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- CMOS low power consumption
- MULTIBYTETM flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- Bus hold on all data inputs
- Integrated 30Ω termination resistor

DESCRIPTION

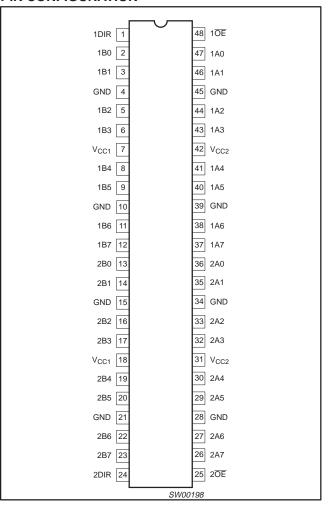
The 74ALVCH162245 is a 16-bit transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions.

The 74ALVCH162245 features two output enable (n\overline{OE}) inputs for easy cascading and two send/receive (nDIR) inputs for direction control. n\overline{OE} controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74ALVCH162245 is designed with 30Ω series resistors in both HIGH and LOW output states.

The 74ALVCH162245 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

PIN CONFIGURATION



QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5$ ns

SYMBOL	PARAMETER	CONDITION	NS	TYPICAL	UNIT		
t _{PHL} /t _{PLH}	Propagation delay An to Bn; Bn to An	V _{CC} = 2.5V, C _L = 30pF V _{CC} = 3.3V, C _L = 50pF	2.4	ns			
C _I	Input capacitance						
C _{I/O}	Input/output capacitance			8.0	pF		
C	Power dissipation capacitance per buffer	$V_{L} = GND \text{ to } V_{CC}^{-1}$	Outputs enabled	27	pF		
C _{PD}	Power dissipation capacitance per buller	AL = GIAD TO ACC.	Outputs disabled	4	pF		

NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where: } f_i = \text{input frequency in MHz; } C_L = \text{output load capacitance in pF; } f_o = \text{output frequency in MHz; } V_{CC} = \text{supply voltage in V; } \Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of the outputs.}$

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	-40°C to +85°C	74ALVCH162245 DL	ACH162245 DL	SOT370-1
48-Pin Plastic TSSOP Type II	-40°C to +85°C	74ALVCH162245 DGG	ACH162245 DGG	SOT362-1

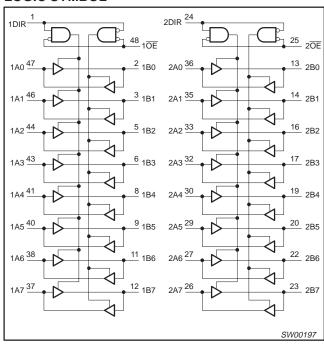
16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	1DIR	Direction control
2, 3, 5, 6, 8, 9, 11, 12	1B0 to 1B7	Data inputs/outputs
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V _{CC}	Positive supply voltage
13, 14, 16, 17, 19, 20, 22, 23	2B0 to 2B7	Data inputs/outputs
24	2DIR	Direction control
25	2 OE	Output enable input (active LOW)
36, 35, 33, 32, 30, 29, 27, 26	2A0 to 2A7	Data inputs/outputs
47, 46, 44, 43, 41, 40, 38, 37 1A0 to 1A7		Data inputs/outputs
48	1 OE	Output enable input (active LOW)

LOGIC SYMBOL



FUNCTION TABLE

INP	JTS	INPUTS/OUTPUT					
nOE	nDIR	nAn	nBn				
L	L	A = B	inputs				
L	Н	inputs	B = A				
Н	Х	Z	Z				

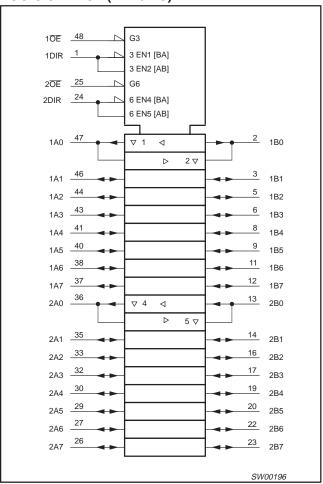
H = HIGH voltage level

L = LOW voltage level

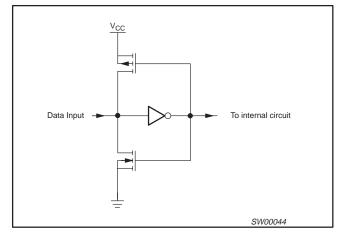
X = don't care

Z = high impedance OFF-state

LOGIC SYMBOL (IEEE/IEC)



BUS HOLD CIRCUIT



16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIM	ITS	UNIT	
STWIBOL	PARAIVIETER	CONDITIONS	MIN	MAX		
V	DC supply voltage 2.5V range (for max. speed performance @ 30 pF output load)		2.3	2.7	V	
V _{CC}	DC supply voltage 3.3V range (for max. speed performance @ 50 pF output load)		3.0	3.6	V	
VI	DC Input voltage range		0	V _{CC}	V	
Vo	DC output voltage range		0	V _{CC}	V	
T _{amb}	Operating free-air temperature range		-40	+85	°C	
t _r , t _f	Input rise and fall times	$V_{CC} = 2.3 \text{ to } 3.0 \text{V}$ $V_{CC} = 3.0 \text{ to } 3.6 \text{V}$	0	20 10	ns/V	

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
\/	DC input voltage	For data inputs with bus hold ¹	-0.5 to V _{CC} +0.5	V
VI	DC Input voltage	For control pins ¹	-0.5 to +4.6	1
I _{OK}	DC output diode current	$V_O > V_{CC}$ or $V_O < 0$	±50	mA
Vo	DC output voltage	Note 1	-0.5 to V _{CC} +0.5	V
I _O	DC output source or sink current	$V_O = 0$ to V_{CC}	±50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		±100	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package –plastic medium-shrink (SSOP) –plastic thin-medium-shrink (TSSOP)	For temperature range: –40 to +125 °C above +55°C derate linearly with 11.3 mW/K above +55°C derate linearly with 8 mW/K	850 600	mW

NOTE

^{1.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltage are referenced to GND (ground = 0 V).

				LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp :	= -40°C to +8	5°C	דואט
			MIN	TYP ¹	MAX	1
		V _{CC} = 2.3 to 2.7V	1.7	1.2		, ,
V_{IH}	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V	2.0	1.5		\ \
.,	1000	V _{CC} = 2.3 to 2.7V		1.2	0.7	,,
V_{IL}	LOW level Input voltage	V _{CC} = 2.7 to 3.6V		1.5	0.8	\ \
		$V_{CC} = 2.3 \text{ to } 3.6 \text{V}; V_{I} = V_{IH} \text{ or } V_{IL}; I_{O} = -100 \mu\text{A}$	V _{CC} -0.2	V _{CC}		
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -4mA$	V _{CC} -0.4	V _{CC} -0.11		1
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -6$ mA	V _{CC} - 0.6	V _{CC} -0.17		1
V_{OH}	HIGH level output voltage	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -4mA$	V _{CC} - 0.5	V _{CC} -0.09		V
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -8mA$	V _{CC} - 0.7	V _{CC} -0.19		1
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -6mA$	V _{CC} -0.6	V _{CC} -0.13		1
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12mA$	V _{CC} -1.0	V _{CC} -0.27		1
		V_{CC} = 2.3 to 3.6V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		GND	0.20	
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 4mA$		0.07	0.40	1
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 6mA$		0.11	0.55	1
V_{OL}	LOW level output voltage	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 4mA$		0.06	0.40	V
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 8mA$		0.13	0.60	1
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 6mA$		0.09	0.55	1
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$		0.19	0.80	1
II	Input leakage current per data pin with bus hold	V _{CC} = 2.3 to 3.6V; V _I = V _{CC} or GND		0.1	5	μΑ
I _{OZ}	3-State output OFF-state current	V_{CC} = 2.3 to 3.6V; V_I = V_{IH} or V_{IL} ; V_O = V_{CC} or GND		0.1	10	μА
I _{CC}	Quiescent supply current	V_{CC} = 2.3 to 3.6V; V_I = V_{CC} or GND; I_O = 0		0.2	40	μΑ
ΔI_{CC}	Additional quiescent supply current given per data I/O pin with bus hold	$V_{CC} = 2.3V$ to 3.6V; $V_I = V_{CC} - 0.6V$; $I_O = 0$		150	750	μА
1 2	Due held LOW sustaining surrent	V _{CC} = 2.3V; V _I = 0.7V	45	-		
I _{BHL} ²	Bus hold LOW sustaining current	V _{CC} = 3.0V; V _I = 0.8V	75	150		μΑ
1 2	Due hold IIICH quetaining commet	V _{CC} = 2.3V; V _I = 1.7V	-45			^
I _{BHH} ²	Bus hold HIGH sustaining current	V _{CC} = 3.0V; V _I = 2.0V	-75	-175		μΑ
I _{BHLO} ²	Bus hold LOW overdrive current	V _{CC} = 3.6V	500			μΑ
I _{BHHO} ²	Bus hold HIGH overdrive current	V _{CC} = 3.6V	-500			μΑ

NOTES:

All typical values are at T_{amb} = 25°C.
 Valid for data inputs of bus hold parts.

16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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AC CHARACTERISTICS FOR $V_{CC} = 2.3V$ TO 2.7V RANGE

 $GND = 0V; \ t_r = t_f \leq 2.0ns; \ C_L = 30pF$

SYMBOL	PARAMETER	WAVEFORM	V	UNIT			
			MIN	TYP ^{1, 2}	MAX		
t _{PHL} /t _{PLH}	Propagation delay nAn to nBn; nBn to nAn	1, 3	1.0	2.5	4.9	ns	
t _{PZH} /t _{PZL}	3-State output enable time nOE to nAn; nOE to nBn	2, 3	1.0	2.9	6.8	ns	
t _{PHZ} /t _{PLZ}	3-State output disable time nOE to nAn; nOE to nBn	2, 3	1.0	3.0	6.3	ns	

NOTES:

1. All typical values are measured $T_{amb} = 25^{\circ}C$.

AC CHARACTERISTICS FOR V_{CC} = 3.0V TO 3.6V RANGE AND V_{CC} = 2.7V

 $GND = 0V; \ t_r = t_f \leq 2.5 ns; \ C_L = 50 pF$

			LIMITS								
SYMBOL	PARAMETER	WAVEFORM	V _C	$_{\text{C}}$ = 3.3 \pm 0	.3V	\	/ _{CC} = 2.7\	/	UNIT		
			MIN	TYP ^{1, 2}	MAX	MIN	TYP ¹	MAX			
t _{PHL} /t _{PLH}	Propagation delay nAn to nBn; nBn to nAn	1, 3	1.0	2.4	4.2	1.0	2.7	4.7	ns		
t _{PZH} /t _{PZL}	3-State output enable time nOE to nAn; nOE to nBn	2, 3	1.0	3.0	5.6	1.0	3.9	6.7	ns		
t _{PHZ} /t _{PLZ}	3-State output disable time nOE to nAn; nOE to nBn	2, 3	1.0	2.6	5.5	1.0	2.9	5.7	ns		

NOTES:

- 1. All typical values are measured T_{amb} = 25°C.
- 2. Typical value is measured at $V_{CC} = 3.3V$

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^{2.} Typical value is measured at $V_{CC} = 2.5V$

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AC WAVEFORMS FOR $V_{CC} = 2.3V$ TO 2.7V AND V_{CC} < 2.3V RANGE

 $V_{M} = 0.5 V_{CC}$ $V_{X} = V_{OL} + 0.15 V_{CC}$ $V_{Y} = V_{OH} - 0.15V$

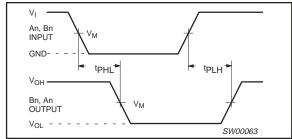
V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

AC WAVEFORMS FOR V_{CC} = 3.0V TO 3.6V AND $V_{CC} = 2.7V RANGE$

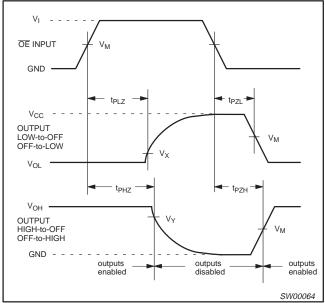
 $V_{M} = 1.5 V$

 $V_X = V_{OL} + 0.3V$ $V_Y = V_{OH} - 0.3V$ V_{OL} and V_{OH} are the typical output voltage drop that occur with the

output load.

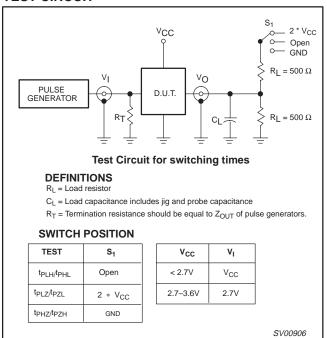


Input (nAn, nBn) to output (nBn, nAn) propagation delay times



Waveform 2. 3-State enable and disable times

TEST CIRCUIT



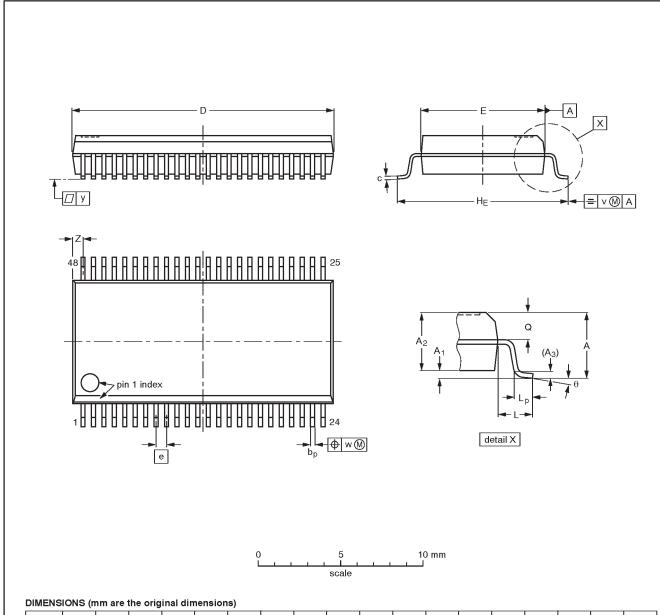
Waveform 3. Load circuitry for switching times

16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

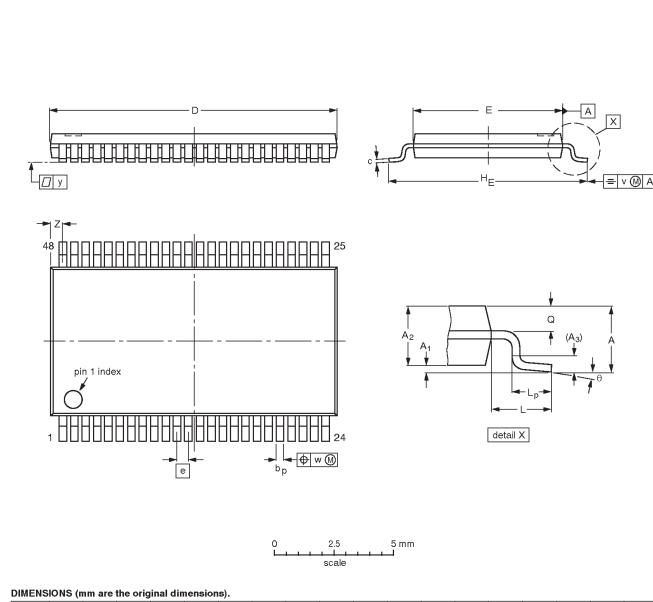
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT370-1		MO-118AA			93-11-02 95-02-04

16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	
SOT362-1		MO-153ED				-93-02-03 95-02-10

16-bit bus transceiver with direction pin and 30Ω termination resistor (3-State)

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Date of release: 06-98

Document order number: 9397-750-04539

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